

Shielded SMD Coupled Inductor – FAUCPR Series



Operating Temp.: -50°C~+150°C

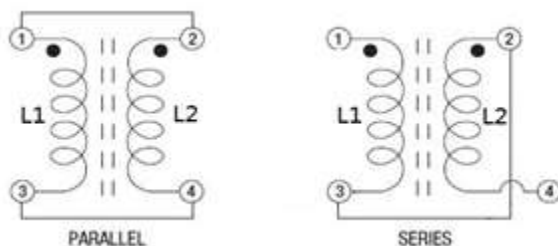
FEATURES

- High efficiency, high coupling
- High rated current, low DC resistance
- RoHS compatible
- AEC-Q200 verified

APPLICATIONS

- SEPIC, Zeta, Flyback topology, etc.
- LED, power supplies
- Used as common mode choke
- Used as transformer

APPLICATION CIRCUIT DIAGRAM



PRODUCT IDENTIFICATION

FAU CP R 1208 S 150 M I
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧

①	Type
FAU	Automotive

②	Type
CP	for Coupled Power Inductor

③	Structure Code
R	R Structure

④	External Dimensions(L×W) [mm]
1208	12.0×8.0

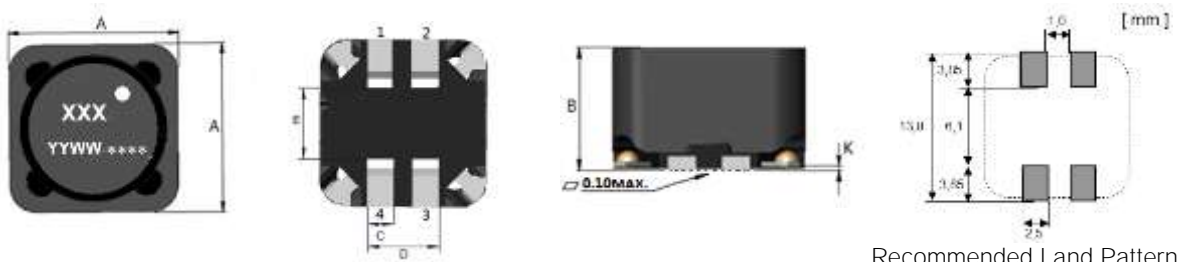
⑤	Feature Type
S	S type

⑥	Nominal Inductance
Example	Nominal Value
150	15μH

⑦	Inductance Tolerance
M	±20%

⑧	Packing
T	Tape & Reel

SHAPE AND DIMENSIONS



Recommended Land Pattern
Unit: mm

Series	A	B	C	D	E	K
FAUCPR1208	12.50 Max	8.50 Max.	1.80±0.20	5.0±0.20	5.0±0.20	0.15Min.
FAUCPR1210	12.50 Max	10.50 Max.	1.80±0.20	5.0±0.20	5.0±0.20	0.15Min.

SPECIFICATIONS

FAUCPR1208S Series

Part Number	Inductance (μH) @100K,0.1V	DCR (mΩ) Max.	Isat Typ.(A)		Irms Typ. (A)
			Inductance drops10%	Inductance drops 30%	
FAUCPR1208S4R7MT	4.7±20%	25	9.2	12.9	5.0
FAUCPR1208S6R8MT	6.8±20%	29	8.1	11.4	4.5
FAUCPR1208S100MT	10±20%	36	6.8	9.8	4.1
FAUCPR1208S150MT	15±20%	40	5.2	7.0	3.6
FAUCPR1208S220MT	22±20%	72	4.7	6.7	3.0
FAUCPR1208S270MT	27±20%	96	3.9	5.7	2.7
FAUCPR1208S330MT	33±20%	105	3.6	5.2	2.5
FAUCPR1208S470MT	47±20%	132	3.1	4.3	2.2
FAUCPR1208S680MT	68±20%	206	2.5	3.6	1.8
FAUCPR1208S101MT	100±20%	280	2.1	3.0	1.5

FAUCPR1210S Series

Part Number	Inductance (μH) @100K,0.1V	DCR (mΩ) Max.	Isat Typ.(A)		Irms Typ. (A)
			Inductance drops10%	Inductance drops30%	
FAUCPR1210S3R9MT	3.9±20%	18	12.5	17.6	7.0
FAUCPR1210S120MT	12.0±20%	28	7.1	10.4	5.6
FAUCPR1210S330MT	33.0±20%	75	4.0	6.2	3.1

Note:※1: Saturation Current: Max. Value, DC current at which the inductance drops less than 30% from its value without current; Typ. Value, DC current at which the inductance drops approximate 30% from its value without current.

※2: Heat Rating Current: DC current that causes the temperature rise (ΔT) from 20°C ambient; For Max. Value, temperature rise (ΔT) is 20°C. For Typ. Value, temperature rise (ΔT) is approximate 40°C.

The part temperature (ambient + temp. rise) should not exceed 150 °C under worst case operating conditions. Circuit design, component placement, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

EQUIVALENT CIRCUIT

